Procedural Review Voting Sheet 2014 Cycle 4

REGION: North America

COMMITTEE: Silicon Wafer EVENT: SEMICON West 2014 DATE OF MEETING: July 8, 2014 PLACE OF MEETING: San Francisco Marriott Marquis, San Francisco, CA COMMITTEE CO-CHAIRS: Noel Poduje (SMS), Dinesh Gupta (STA) SEMI STAFF: Kevin Nguyen

A&R Voter: Name/Company Date: 200X/MM/DD

I. Document Number & Title

Document 5604	Line Item Revision to SEMI M1-0414, Specification for
	Polished Single Crystal Silicon Wafer and SEMI M20-
	0110, Practice for Establishing a Wafer Coordinate System

II-1 Line item 1

Line Item 1	Revise both SEMI M1 and SEMI M20 to add a notchless
	category of 450 mm diameter wafers

1. Tally (Staff to fill in)

Voting Tally: As-cast tally after the close of the voting period

A minimum of 60% of the voting interests that have voting members within the technical committee must return votes. (Regulations \P 9.6.1)

	Return	Distribution Return Rate
Yellow	53	\div 86 = 61.6% >=60%
Lilac & Others	27]
Total Vote	80]
Reject	0]
Accept	39]

		Not approved
A&R	Re	eason:

2. Rejects There was no reject submitted for ballot 5604 of line item 1.

3. Comments

_	C	omm	ent 1	
Comment			tion	Abstain with comments I think this is just editorial, probably generated by Word at some point: Starting on page 6, there is a renumbering of Footnotes for Table 2, e.g., #6 > #5 #7 > #6 This renumbering suggests that a prior #5 was deleted, which I don't believe was the case (however, if this was the case, then this comment would be other than editorial)
		Fr	om	Richard Allen (NIST)
		Com	iment	
	Discussion			The last published version, the footnote subscripts need to be corrected. As listed above, #6 should be #5, and #7 should be #6. No committee action is needed. SEMI Publication will correct it.
	The commi		e commit	tee agreed to do one of the following actions.
	^	*No motion		is required in this step.
		х		er action was taken by the committee.
				the task force for more consideration.
			New Bus	siness
			Other	
Action propos	Editorial Change			
ed			Case 1:	No vote in this section :
		х	To be in	cluded and voted on in <u>4. Summary of Editorial Changes</u> .
			Case 2:	Voted in this section :
			Original "TO" fie	section number and at least one full sentence are required in "FROM" and elds.
		1	FROM:	Section xxx

		To: \$	Section xxx
		Just	ification (If necessary)
		FRO	M: Section xxx
	2	To: Section xxx	
		Just	ification (If necessary)
Mot	ion b	y/2nd	Name (Company)/Name (Company)
	Vot	е	XX-XX Motion passed (or failed)
A&	R	N	ot approved
AG	IX .	Reason:	

Comment 2

	Comment 2			
Comment	Referenced Section			Accept with comments ID marking specification for 450mm only requires T7, and does not say anything about an option for a human readable ID mark (SEMI M12 OCR). This is an oversight that should be corrected in a subsequent revision.
en		Fr	om	Robb Robles (Cognex)
Ŧ			nment	The task force recommends the committee that this change is not appropriate.
	[Discu	ussion	The task force recommends the committee that this change is not appropriate.
		Th		tee enneed te de ene ef the fellowing estience
	x			tee agreed to do one of the following actions.
		*No motion i		is required in this step.
		х	No furthe	er action was taken by the committee.
			Refer to	the task force for more consideration.
			New Bus	siness
Þ			Other	
Action proposed	Editorial Change			
			Case 1:	No vote in this section :
			To be in	cluded and voted on in <u>4. Summary of Editorial Changes</u> .
			Case 2:	Voted in this section :

		Origin "TO"	al section number and at least one full sentence are required in "FROM" and fields.	
		FROM	I: Section xxx	
	1	To: Section xxx		
		Justification (If necessary)		
		FROM: Section xxx		
	2	To: Section xxx		
		Justification (If necessary)		
Mot	ion b	y/2nd	Name (Company)/Name (Company)	
	Vot	e	XX-XX Motion passed (or failed)	
A&	R	No	ot approved	
Add		Reason:		

Comment 3

0	Referenced Section			Accept with comments The notchless wafer surely has many technical merits such as a damage free around notch and an increase of FQA, etc. In the economic views, I still think that the notchless wafer standard is premature. I go for support for the notchless wafer standard in the technical
Comment		Fr	om	views such as manufacturing process and measuring technique, etc.
	Comment			
	Discussion			The TF recommends to the committee that no action is necessary
	The committee agreed to do one of the following actions.		e commit	tee agreed to do one of the following actions.
ри ,	X	*No motion		is required in this step.
ACTION		х	No furth	er action was taken by the committee.
			Refer to	the task force for more consideration.
2			New Bu	siness
	Other			

	Editorial Change					
			Case	1: No vote in this section :		
			To be	included and voted on in <u>4. Summary of Editorial Changes</u> .		
	ľ		Case	2: Voted in this section :		
			Original section number and at least one full sentence are required in "FROM" and "TO" fields.			
			FROM: Section xxx			
		1	To: Section xxx			
			Justification (If necessary)			
			FROM: Section xxx			
		2	To: S	ection xxx		
			Justification (If necessary)			
М	oti	ion k	h by/2nd Name (Company)/Name (Company)			
	V		Vote XX-XX Motion passed (or failed)			
Δ	. . .	R	No	ot approved		
	A&R		Reason:			

Comment 3

Comment	Referenced Section	Accept with comments As foreseen the 3 fiducials are at uneven angles, but only of 1° difference. A bigger angle difference between each of the fiducial could in some cases add a way to quickly determine the current position while aligning wafers (measuring the angle btw 2 fiducials)
	From	Thomas Brillouet (RECIF Technologies)
	Comment	

		Discu	ussion	The TF recommends to the committee that no change is necessary.
		The	e comm	ittee agreed to do one of the following actions.
	X	*No	motion	is required in this step.
		х	No furt	her action was taken by the committee.
			Refer t	o the task force for more consideration.
			New B	usiness
			Other	
	Editorial Change			
Act			Case 1	: No vote in this section :
Action proposed			To be i	included and voted on in <u>4. Summary of Editorial Changes</u> .
orop			Case 2	: Voted in this section :
osed			Origina "TO" f	al section number and at least one full sentence are required in "FROM" and ields.
			FROM	: Section xxx
		1	To: Se	ection xxx
			Justifi	cation (If necessary)
			FROM	: Section xxx
		2	To: Section xxx	
			Justifi	cation (If necessary)
Ν	Not	ion b	y/2nd	Name (Company)/Name (Company)
		Vot	e	XX-XX Motion passed (or failed)
	A&	R	No	t approved
		Reason		n:

4. Summary of Editorial Changes Note: Original section number and at least one full sentence are required in "FROM" and "TO" fields.

	FROM: Section XXX								
1	TO: Section XXX								

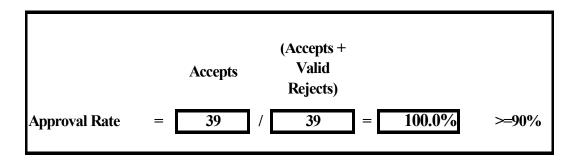
	Justification: (If necessary)							
	FROM: Section XXX							
2	TO: Section XXX							
	Justi	Justification: (If necessary)						
Μ	lotion	To approve the above editorial changes						
	tion by and by	Name (Company) / Name (Company)						
	cussion	XXXX						
V	Vote	XX-XX Motion passed (or failed)						
	&R	Not approved						
A	an	Reason:						

5. Approval Conditions Check

APPROVAL CONDITION 1: All negatives have been discussed and were withdrawn, found not related, or not persuasive. (Regulations \P 9.6.2)

APPROVAL CONDITION 2: At least 90% of the sum of the valid accept and reject votes must be accept. (Regulations \P 9.6.3)

Note: if both approval conditions are not satisfied, the balloted item fails.



6. Preliminary action for this line item

	x	This line item passed committee review as balloted.						
Motion		This line	This line item passed committee review with editorial changes					
Ň		This line item failed committee review and will be returned to the task force for rework.						
		This line item failed committee review and work will be discontinued.						
Μ	fotion by/ 2nd by		Noel Poduje (SMS)/Pinyen Lin (G450C)					
	Disc	cussion	None					

A&R Ballot Report Template - Line Items Revision 7.2

Vote		15-0				
Final Act	x Motion passed					
Final Act	1011		Motion failed			
		App	pproved			
A&R		Not	lot approved			
	Reason:					

III. Safety Check

This section applies to the entire document. See Section 14 of the Regulations for further information

	x	This is not a Safety Document: when all safety-related information is removed, the document is still technically sound and complete.							
Motion:		This is a Safety Document: when all safety-related information is removed, the document is not technically sound and complete.							
Safety Checklist is complete and has been included with the docume (Regulations ¶ 14.3)				klist is complete and has been included with the document throughout the balloting process. s \P 14.3)					
	Moti	ion k	y/ 2nd by	Noel Poduje (SMS)/Pinyen Lin (G450C)					
]	Discu	ission	None					
		V	ote	11-0 Motion passed					
	A&I	R	Not ap Reason:	proved					

IV. Intellectual Property Check Note: This ballot may be all or part of a Standard or Safety Guideline. This IP check applies to the entire Standard or Safety Guideline. See § 15 of the Regulations for further information

х		meeting chair asked those present in person or by electronic link, if they were aware of any ntially material patented technology or copyrighted items* in the Standard or Guideline.							
			otentially n nown	GO TO SECTION IX					
		Potentially material patented technology or copyrighted items are known but a Letter of Assurance (LOA) or copyright release for such material has been obtained or presented to the committee.							
	x	Potentially material patented technology or copyrighted items are known but an LOA or copyright release for some of the material(s) has NOT been obtained or presented to the committee							
	MOTION		Ask ISC f	ISC for special permission to publish					
			Quit activ	ty					
	Ň	х	Wait for L	OA for patented technology or release of copyrighted items.					
	Мо	tion by	y/2 nd by	Noel Poduje (SMS)/ Mike Goldstein (Intel)					
	C	Discus	sion	Pinyen Lin: There is a published patent application TSMC_US2013258339A1					

		Vote		7-1	
	-			х	Motion Passed
	Final Action			Motion Failed	
•	A&R Not appro Reason:		Not appro	oved	
A					

* Note: Such potentially material patented technology or copyrighted items might have become known since the Standard or Safety Guideline was last reviewed, or might become relevant due to this ballot.

V. Action for this document

= 0	x		Line item(s) [1] passed committee review as balloted and will be forwarded to the A&R for procedural review.						
Motion (Check a applicabl items)			Line item(s) [X], [X] and [X] passed committee review with editorial changes and will be forwarded to the A&R for procedural review.						
app ite		rewor	ine item(s) [X], [X] and [X] failed committee review and will be returned to the task force for work.						
		Line	item(s) [X], [X] and [X] failed committee review and work will be discontinued.						
Motion by	y/ 2n	d by	Noel Poduje (SMS)/Pinyen Lin (G450C)						
Discu	ssior	ı	Pinyen: He believes that TSMC will offer an LOA with free and open license.						
Vo	te		3-6						
Einal			Motion passed						
FINAL F	Action		x Motion failed						
		Арри	oved						
A&R		Not a	ot approved						
	Re	Reason:							

Motion: Noel Poduje (SMS) moved to that the NA TC Chapter Silicon Wafer Technical Committee request GCS to allow the final portion of adjudication of this document to be moved to the first international meeting after receipt and acceptance of the LOA by SEMI Seconded: Pinyen Lin (G450C) Vote: 15-0 in favor. Motion passed.